



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): WonSun Shin, et al.

Assignee: Amkor Technology, Inc.

Title: SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING
THE SAME

Serial No.: 10/785,528 Filed: February 24, 2004

Examiner: Chuong A. Luu Group Art 2818
Unit:

Docket No.: GK001102

Monterey, CA
October 24, 2006

Mail Stop AF
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

RESPONSE

Dear Sir:

This is in response to the Final Office Action dated
August 24, 2006:

1. Remarks begin on page 2 of this paper.